



AK7451

Zero Latency Angle Sensor IC

1. General Description

The AK7451 is a magnetic rotational angle sensor IC of Si monolithic with a built-in Hall element, and easily achieve a non-contact rotation angle sensor in combination with diametrically magnetized two pole magnet.

By detecting the magnetic field parallel vector to the IC package surface, the AK7451 outputs the absolute angular position of the magnet, and the relative angular position.

By transverse magnetic field detection method using a magnetic flux concentrator, the AK7451 has excellent axial misalignment immunity.

AK7451 is the Zero Latency rotation angle sensor to follow up to 20,000rpm with the architecture of the tracking servo system, it is suitable to various motor drive applications and an encoder applications.

2. Features

- ☐ Monolithic integrated 360 degrees angle sensor IC containing Hall element.
- ☐ Easy to make a contactless rotation sensor with diametrically magnetized two pole magnet.
- ☐ Interfaces : SPI(absolute angle), ABZ phase output (incremental Interface), UVW phase output
- ☐ 12bit angle resolution
- ☐ Less than ± 0.6 deg. angle accuracy at 25 °C
- ☐ Maximum tracking speed : 333 rps (20,000 rpm)
- ☐ Angle output delay time: 1.8 μ s
- ☐ Operating ambient temperature: -40 to 125°C
- ☐ Various abnormal detection; abnormal magnetic flux density range etc.
- ☐ Various setting functions; angle zero point, rotation direction, ABZ resolution/hysteresis etc.

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4. Block Diagram and Functions

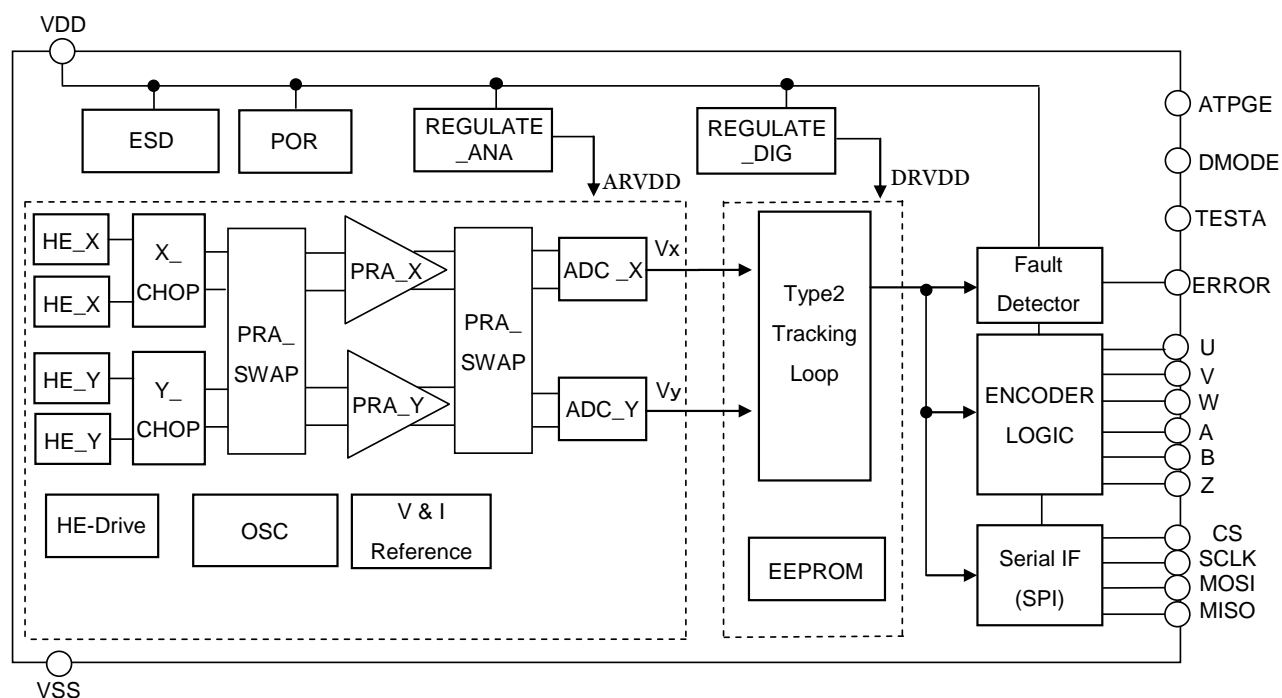


Figure 1. Functional block diagram of AK7451

Table 1. Description of circuit block

| Circuit Block | Function |
|---------------------|--|
| HE-X/Y | Si monolithic Hall elements. These detect X/Y-compositions of flux which are parallel to the IC package surface by using the magnetic concentrator and converts to an electrical signal. |
| X_CHOP, Y_CHOP | Switch its direction of drive current in order to lower offset and noise for the Hall elements. |
| HE Drive | Drive Hall elements by constant current. |
| PRA_X,PRA_Y | Amplify signals from Hall elements. |
| PRA_SWAP | Reduce mismatch of each amplifier gain and Hall element current. |
| ADC_X, ADC_Y | AD converter for converting the Hall electromotive force signal amplified in the preamplifier into a digital signal. |
| OSC_8MEG | Generate a master clock (8 MHz). |
| V & I Reference | Generate reference voltage / current. |
| Type2 Tracking Loop | Closed loop circuit to calculate an angle from the digitalized Hall signal. |
| POR | Power-On-Reset circuit. |
| REGULATE_ANA | Regulate the power supply voltage and generate the internal ARVDD which is for analog circuit. |
| REGULATE_DIG | Regulate the power supply voltage and generate the internal DRVDD which is for digital circuit. |
| EEPROM | Non-volatile memory. |
| Fault Detector | Detect abnormal status such as magnetic flux density range and losing tracking state. |
| Encoder Logic | Generate ABZ and UVW phase signal based on absolute angle data. |
| Serial IF | 4-wire SPI interface circuit. |
| ESD | Protection circuit for ESD |

5. Pin Configurations and Functions

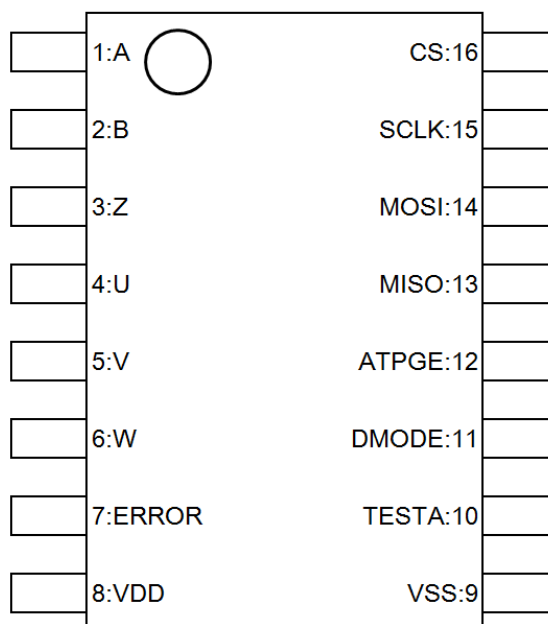


Figure 2. Pin assignment of AK7451

Table 2. Pin configuration and functions of AK7451

| No. | Pin Name | I/O | Type | Description |
|-----|----------|-----|---------|--|
| 1 | A | O | Digital | A-phase Pulse Signal |
| 2 | B | O | Digital | B-phase Pulse Signal |
| 3 | Z | O | Digital | Z-phase Pulse Signal |
| 4 | U | O | Digital | U-phase Pulse Signal |
| 5 | V | O | Digital | V-phase Pulse Signal |
| 6 | W | O | Digital | W-phase Pulse Signal |
| 7 | ERROR | O | Digital | ERROR output PIN |
| 8 | VDD | - | Power | Power Supply PIN |
| 9 | VSS | - | GND | Ground PIN |
| 10 | TESTA | I/O | Analog | TEST dedicated PIN. This pin should be non-connection. |
| 11 | DMODE | I | Digital | TEST dedicated PIN. This pin should be non-connection. |
| 12 | ATPGE | I | Digital | TEST dedicated PIN. This pin should be non-connection. |
| 13 | MISO | O | Digital | SPI output data signal |
| 14 | MOSI | I | Digital | SPI Input Data Signal |
| 15 | SCLK | I | Digital | SPI Clock Signal |
| 16 | CS | I | Digital | SPI Chip Select Signal |

6. Absolute Maximum Ratings

Table 3. Absolute Maximum Ratings

| Parameter | Symbol | Min. | Max. | Units | Notes |
|--------------------------------|------------|-------|------------------------------------|-------|---|
| Power Supply Voltage | V_{DDA} | -0.3 | 6.5 | V | VDD pin |
| Voltage on Output pin | V_{OUT} | -0.3 | V_{DDA} | V | MISO, ERROR, A, B, Z, U, V, W pin |
| Output Current on Output pin 1 | I_{OUT1} | -1.25 | 1.25 | mA | MISO pin |
| Output Current on Output pin 2 | I_{OUT2} | -10 | 10 | mA | ERROR, A, B, Z, U, V, W pin |
| Input pin Voltage | V_{IN} | -0.3 | $V_{DDA} + 0.3$ ($\leq 6.5V$) | V | MOSI, CS, SCLK, DMODE, ATPGE, TESTA pin |
| Storage temperature | T_{STG} | -50 | +150 | °C | |

WARNING: Stress beyond these listed values may cause permanent damage to the device. Even it may not cause damage on the device; it may affect its reliability and longevity.

Normal operation is not guaranteed. Each voltage is with respect to VSS pin.

7. Recommended Operating Conditions

Table 4. Operating conditions

| Parameter | Symbol | Min. | Typ. | Max. | Units | Notes |
|---|----------|------|------|------|-------|---------|
| Power Supply Voltage under Operating Conditions | V_{DD} | 4.5 | 5 | 5.5 | V | VDD pin |
| Operating Ambient Temperature | T_a | -40 | - | +125 | °C | |

WARNING: Exceeding the operation conditions, the electric and magnetic characteristics are not guaranteed. Voltage is with respect to VSS pin.

8. EEPROM Characteristics

Table 5. EEPROM Characteristics

Conditions : $V_{DD} = 4.5$ to $5.5V$

| Parameter | Symbol | Min. | Typ. | Max. | Units | Notes |
|--------------------------------|-----------|------|------|------|-------|-------|
| Endurance to rewriting | W_f | | | 1000 | cycle | |
| Ambient Temperature in writing | T_{MEM} | 0 | | 85 | °C | |
| Writing time | W_t | | | 5 | ms | |

9. Electrical and Magnetic Characteristics

Table 6 . Electrical and Magnetic Characteristics

Conditions (unless otherwise specified) : $T_a = -40$ to 125°C , $V_{DD} = 4.5$ to 5.5V

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------------|--------------------|--|------|-------|-------|---------------|
| Magnetic Flux Density Range | B_{RANGE} | | 30 | 50 | 70 | mT |
| Angle Detection Range | A_{RANGE} | | 0 | | | deg. |
| Angle Resolution | A_{RES} | 12bit | | 0.088 | | deg. |
| Angle Linearity Error (Note 1) | A_{INL} | at 25°C | -0.6 | | +0.6 | deg. |
| Thermal Angle Drift | A_{DRIFT} | Operating temperature range (with reference to 25°C) | -0.9 | | +0.9 | deg. |
| Angle hysteresis Width | A_{HYS} | at 25°C | | | 0.3 | deg. |
| Output noise | H_{NOISE} | at 50mT | -2 | | 2 | LSB |
| Angle Tracking Ability | F_{SAMP} | | | | 20000 | rpm |
| Angle Output Delay Time (Note 2) | T_D | at ABZ hysteresis configuration ="Invalid" | | | 1.8 | μs |
| Power On Time (Note 3) | T_{STO} | | | 25 | 30 | ms |
| Supply current | I_{SUP} | No Output Load | | 12.7 | 15.7 | mA |

Note 1. If ABZ resolution configuration is set to other than exponentiation of 2, the father angle linearity error is added to the specified value in 0 to 1LSB (0 to 0.088degree).

Note 2. This value is in case that ABZ hysteresis configuration is set to "Invalid". This value is dependent on ABZ hysteresis configuration. Whenever the setting value is increased, the angle output delay time value increases by $0.5\mu\text{s}$ at a time.

Note 3. It is the time from Power-On to becoming high on ERROR pin through judging magnetic flux range error and tracking error. This time is including the circuit setup time, the tracking angle time, the self-diagnosis of error time. This parameter is not tested at mass production.

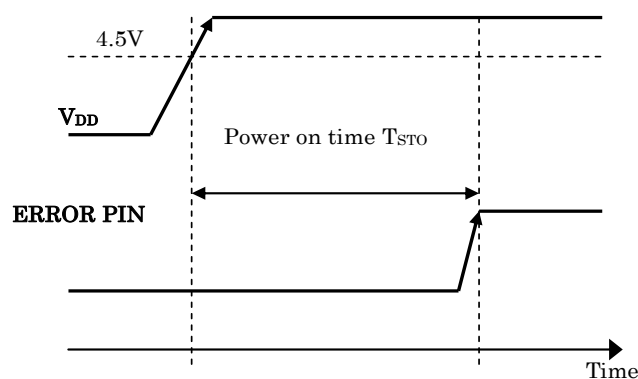


Figure 3. Waveform of VDD and ERROR pin at start-up

| |
|---|
| 10. Serial Interface Characteristics |
|---|

Table 7. Serial I/F DC Characteristics

Conditions : Ta=-40 to 125°C, V_{DD}=4.5 to 5.5V

| Parameter | Symbol | PIN | Conditions | Min. | Typ. | Max. | Unit |
|----------------------|------------------|---------------|-------------------------------|--------------------|------|--------------------|------|
| Input High Level | V _{HSI} | CS,SCLK, MOSI | | 0.7V _{DD} | | | V |
| Input Low Level | V _{LSI} | CS,SCLK, MOSI | | | | 0.3V _{DD} | V |
| Input Current | I _{SI} | CS,SCLK, MOSI | | -10 | | +10 | μA |
| Output Current | I _{SO} | MISO | | -1 | | 1 | mA |
| Output High Level | V _{HSO} | MISO | I _{SO} =1mA (source) | 0.8V _{DD} | | | V |
| Output Low Level | V _{LSO} | MISO | I _{SO} =1mA (sink) | -0.3 | | 0.2V _{DD} | V |
| Output Load Capacity | C _{SO} | MISO | | | | 100 | pF |

Table 8. Serial I/F AC Characteristics

Conditions : Ta=-40 to 125°C, V_{DD}=4.5 to 5.5V

| Parameter | Symbol | Min | Typ. | Max | Unit | Notes |
|--|--------|-------|------|------|------|-------|
| Time from fall of CS to start of CLK | t1 | 100 | | | ns | |
| Necessary Time from end of SCLK to rise of CS | t2 | 100 | | | ns | |
| Set-up time of input data | t3 | 70 | | | ns | |
| Hold time of input data | t4 | 70 | | | ns | |
| Time to fix output data | t5 | | | 150 | ns | |
| Time from rise of CS to Hi-Z of MISO | t6 | 0 | | 500 | ns | |
| Transition time from 0.2V _{DD} to 0.8V _{DD} of output data | t7 | | | 100 | ns | |
| Transition time from 0.8V _{DD} to 0.2V _{DD} of output data | t8 | | | 100 | ns | |
| SCLK High time | t9 | 200 | | | ns | |
| SCLK Low time | t10 | 200 | | | ns | |
| SCLK Rise time (Note 4) | t11 | | | 30 | ns | |
| SCLK Fall time (Note 4) | t12 | | | 30 | ns | |
| Idle time in writing register | t13 | 2.5 | | | μs | |
| Idle time in writing EEPROM | t13 | 5 | | | ms | |
| SCLK Frequency | - | 0.001 | | 2000 | kHz | |

Note 4. These parameters are not tested at mass production.

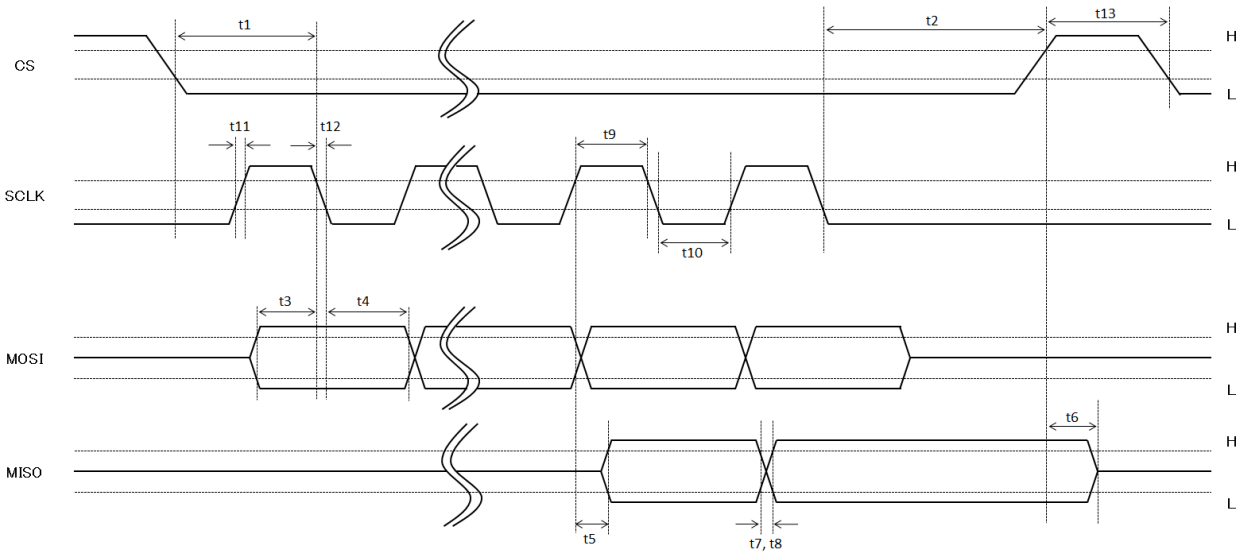


Figure 4. AC Timing of Serial I/F

11. Digital Output Characteristics

Table 9. Digital Output DC Characteristics
 Conditions :Ta=-40 to 125°C, V_{DD}=4.5 to 5.5V

| Parameter | Symbol | Pin | Notes | Min | Typ. | Max | Unit |
|----------------------|------------------|---------------------------|------------------------------|--------------------|------|--------------------|------|
| Output Current | I _{DO} | A,B,Z, U,V,W, ERROR | | -2 | | 2 | mA |
| Output Low Level | V _{LDO} | A,B,Z, U,V,W, ERROR | I _{DO} =2mA(sink) | -0.3 | | 0.2V _{DD} | V |
| Output High Level | V _{HDO} | A,B,Z, U,V,W, ERROR | I _{DO} =2mA(source) | 0.8V _{DD} | | | V |
| Output Load Capacity | C _{DO} | A,B,Z, U,V,W, ERROR | | | | 100 | pF |

Table 10. Digital Output AC Characteristics
 Conditions :Ta=-40 to 125°C, V_{DD}=4.5 to 5.5V

| Parameter | Symbol | Pin | Notes | Min | Typ. | Max | Unit |
|-----------|------------------|---------------------------|--|-----|------|-----|------|
| Rise time | T _{RDO} | A,B,Z, U,V,W, ERROR | C _{DO} =100pF, I _{DO} =2mA(source) Time from 0.2V _{DD} to 0.8V _{DD} | | | 150 | ns |
| Fall time | T _{FDO} | A,B,Z, U,V,W, ERROR | C _{DO} =100pF, I _{DO} =2mA(sink) Time from 0.8V _{DD} to 0.2V _{DD} | | | 150 | ns |

12. Instructions

The AK7451's function is described in this section. The function is roughly divided into programming procedure (for various setup) and an angle measurement procedure. The operation procedure is as follows.

<Programming Procedure>

1. The AK7451 will start as "Normal Mode" after power on automatically.
2. Transfer to "User Mode" and write configuration parameters in EEPROM and then verify the data.
3. Transfer to "Normal Mode" and then The AK7451 will output the angle data based on programmed parameter.

<Normal Operation (Angle measurement)>

1. Transfer to "Normal Mode".
2. Input the "read angle command" as OPCODE"1001" via SPI, when the absolute angle data is needed. If relative angle data is needed, count the ABZ output pulses. The ABZ pulses and UVW pulses are outputted right after startup along with magnet rotating.

13. Mode Transition Diagram and Conditions

This IC has the following two modes and starts with “Normal Mode” at start up.

In the “Normal Mode”, this sensor will be operated as angle output mode. User can read the angle data via SPI pin and ABZ pin and also can transfer to “User Mode” by using specific OPCODE. And also in this mode, UVW output is available to detect the magnet rotor position in BCDL motor driving.

In the “User Mode”, the user can set the various operation conditions via SPI communication. The settable item will be described later in this section.

| Mode name | Note |
|-------------|---|
| Normal Mode | In this mode, The absolute angle data including error bit, parity bit and mode information will be outputted via SPI communication by inputting specific OPCODE. And the ABZ and UVW pulses are outputted automatically along with magnet rotating. |
| User Mode | Do not use the angle data (ABZ and UVW pulses) in this mode. The following functions are available in this mode. a. Magnetic flux density measurement b. Abnormal state checking c. Memory lock d. Angle zero position setting e. ABZ output enable/disable and resolution, hysteresis setting f. Abnormal detection enable/disable setting g. Rotation direction setting h. UVW output enable/disable and the number of output pulses, hysteresis setting |

Note 5. In user mode, output on ERROR PIN is low state (abnormal status). And the accuracy of magnetic flux density measurement is not guaranteed.

Each mode can be changed by writing specific OPCODE and specific data on specific address as the diagram below.

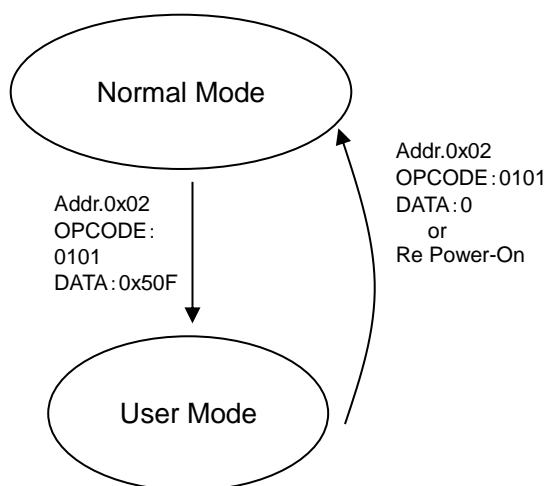


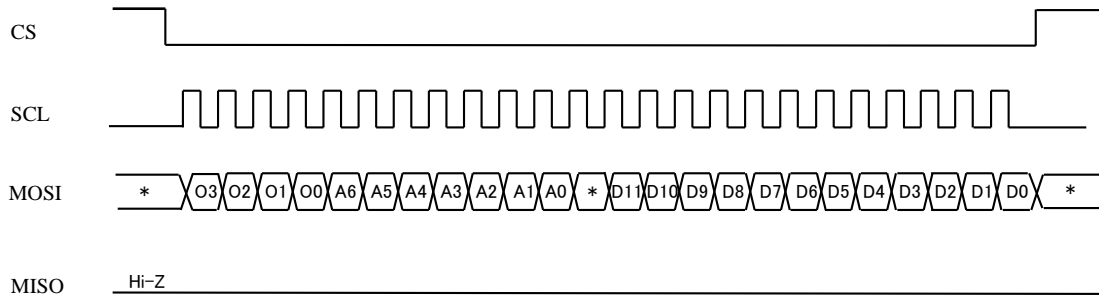
Figure 5. Mode transition diagram

14. Serial Interface

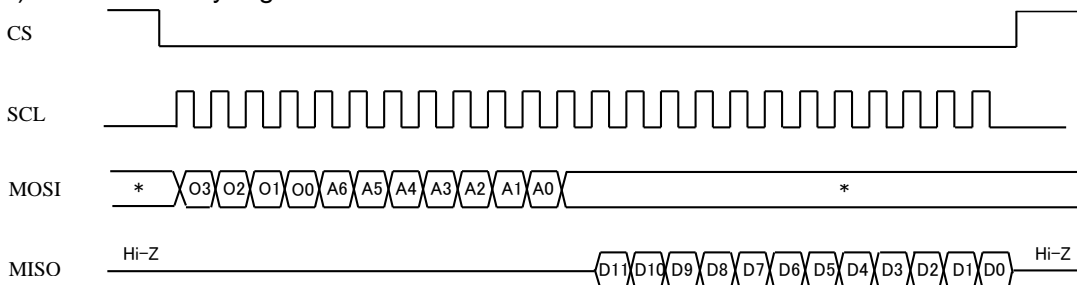
When register/memory setting or absolute angle measurement is needed, use SPI communication.
The serial communication protocol and each register/memory description are described in this section.

● Data format

1) Write memory/register in User Mode



2) Read memory register in User Mode



3) Read angle data in Normal Mode

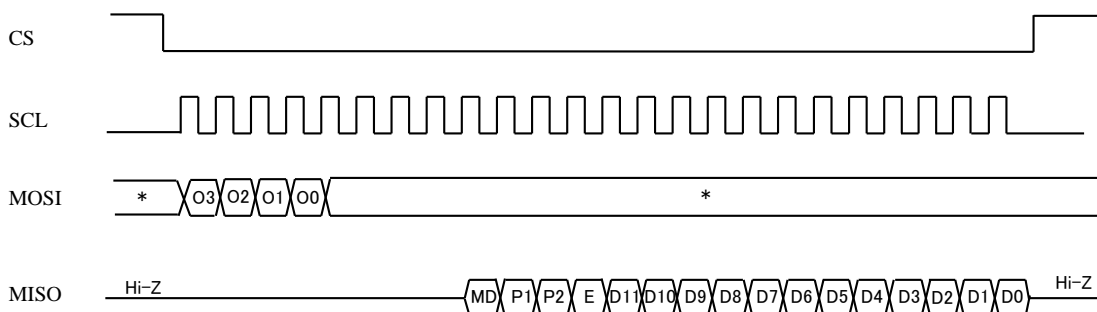


Figure 6. Timing Chart of Serial I/F

Note 6. Figure symbols are as following;

- 'Ox': Operation Code
- 'Ax': Memory/Register Address
- 'MD': Mode Information (MD is "0" in Normal Mode, And "1" in User Mode)
- 'Dx': Data
- 'P1': Parity Bit for Angle Data[11:6]
- 'P2': Parity Bit for Angle Data[5:0]
- 'E': Error Bit (Normal=1, Abnormal=0)
- '*': Don't Care.

Note 7. Parity bit is odd parity in normal and even parity in abnormal. And the ABZ hysteresis configuration which is described later in this section is reflected in read angle data.

Note 8. Send data and receive data are from MSB to LSB in sequence.

Table 11. OPCODE Specification

| OPCODE[3:0] | OPCODE name | Note |
|-------------|------------------|---|
| 0000 | N.A. | |
| 0001 | Write EEPROM | Able to write a data on EEPROM. |
| 0010 | Read EEPROM | Able to read an EEPROM. |
| 0011 | Write Register | Able to write a data on register. |
| 0100 | Read Register | Able to read a register. |
| 0101 | Change MODE | Able to change between normal mode and user mode. Transition conditions are described in '14.1. Mode Transition Diagram and Conditions '. |
| 0110 | N.A. | |
| 0111 | N.A. | |
| 1000 | Angle Data Renew | Update the ANG, MAG, ERRMON, ERR bit data. |
| 1001 | Read Angle | Read the angle data. |
| 1010 | N.A. | |
| 1011 | N.A. | |
| 1100 | N.A. | |
| 1101 | N.A. | |
| 1110 | N.A. | |
| 1111 | N.A. | |

15. Register / EEPROM Address Map / Configuration

● Register Address Map

Table 12. Register Address Map

| Addr. [HEX] | Register symbol | R/W Permission | | Note |
|----------------|--------------------|----------------|--------------|---|
| | | Normal Mode | User Mode | |
| 0x00 | R_ANG | R | R | 12bit angle data |
| 0x01 | R_MAG | N.A. | R | Magnetic flux density strength (roughly 1LSB/mT) |
| 0x02 | R_CHMD | W | R/W | For mode state |
| 0x03 | R_ERRMON | N.A. | R | Error monitor (This register will show what kind of error is.) |
| 0x04 | - | N.A. | N.A. | |
| 0x05 | - | N.A. | N.A. | |
| 0x06 | R_ZP | N.A. | R/W | For set up angle zero point |
| 0x07 | R_RDABZ | N.A. | R/W | For set up "Rotation direction", "Z phase output form", "ABZ output enable/disable", "ABZ Hysteresis" and "ABZ resolution". |
| 0x08 | R_MLK | N.A. | R | For memory lock |
| 0x09 | R_EBDIS | N.A. | R/W | For set up abnormal detection disable |
| 0x0A | R_UVW | N.A. | R/W | For set up "UVW output enable/disable", "UVW Hysteresis" and "UVW resolution". |

Note 9. N.A. = Not Available, R = Read Only, R/W = Read and Write

Note 10. Address 0x02 is only able to be changed by writing OPCODE"0101"

● Each Register Configurations

- R_ANG Register (Register Address:0x00)

| R_ANG | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-------------|-----|----|----|----|----|----|----|----|----|----|----|
| Content | R_ANG[11:0] | | | | | | | | | | | |

Register Function: This register contains an output angle data. The angle data consists with the following angle position. And the ABZ hysteresis configuration which is described later in this section is reflected in this register's value.

| Angle Position [°] | R_ANG[11:0] |
|--------------------|-------------|
| 0 | 0x000 |
| (360÷4096) ×1 | 0x001 |
| (360÷4096) ×2 | 0x002 |
| (360÷4096) ×3 | 0x003 |
| ⋮ | ⋮ |
| (360÷4096) ×4095 | 0xFFF |

- R_MAG Register (Register Address:0x01)

| R_MAG | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|------------|-----|----|----|----|----|----|----|----|----|----|----|
| Content | R_MAG[6:0] | | | | | | | | | | | |

Register Function: This register contains a magnetic flux density strength data. The magnetic flux density strength data consists with the following magnetic flux density strength.

| Magnetic Flux Density Strength [mT] | R_MAG[6:0] |
|-------------------------------------|------------|
| 0 | 0x00 |
| 1 | 0x01 |
| 2 | 0x02 |
| 3 | 0x03 |
| ⋮ | |
| 127 | 0x7F |

Note 11. This magnetic flux density measurement data's accuracy which is stored in this register is not guaranteed, It is recommended to use for only reference.

- R_CHMD Register (Register Address : 0x02)

| R_CHMD | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|--------------|-----|----|----|----|----|----|----|----|----|----|----|
| Content | R_CHMD[11:0] | | | | | | | | | | | |

Register Function: This register is to configure the mode (Normal Mode/User Mode). This register can be written by using OPCODE [0101]. Each mode configuration is the following.

| Mode | R_CHMD[11:0] | Default |
|-------------|--------------|---------|
| Normal Mode | 0x000 | • |
| User Mode | 0x50F | |

- R_ERRMON Register (Register Address : 0x03)

| R_ERRMON | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----------|-----|-----|----|----|----|----|----|----|----|----|----------------|----|
| Content | | | | | | | | | | | R_ERRMON [1:0] | |

Register Function : This register shows the error state. Corresponding bit data is 0 in the abnormal state. Relation between the abnormal state and bit data is the following.

| Abnormal State | Bit data | Value in Abnormal State | Value in Normal State |
|--|-------------|-------------------------|-----------------------|
| Magnetic Flux Density Strength Abnormity | R_ERRMON[1] | 0 | 1 |
| Tracking Lost | R_ERRMON[0] | 0 | 1 |

- R_ZP Register (Register Address : 0x06)

| R_ZP | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|------------|-----|----|----|----|----|----|----|----|----|----|----|
| Content | R_ZP[11:0] | | | | | | | | | | | |

Register Function: This register is available for setting arbitrarily angle position as zero position. Relation between the angle position and the ZP data is the following. The register value is duplicated from corresponding memory after power on or, when the mode transferred to "Normal Mode" from "User Mode".

| Zero Point Angle Position [°] | R_ZP[11:0] | Default |
|----------------------------------|------------|---------|
| 0 | 0x000 | ● |
| (360÷4096) ×1 | 0x001 | |
| (360÷4096) ×2 | 0x002 | |
| (360÷4096) ×3 | 0x003 | |
| ⋮ | ⋮ | |
| (360÷4096) ×4095 | 0xFFFF | |

Note 12. A setup of this register is reflected in ABZ and UVW output.

- R_RDABZ Register (Register Address : 0x07)

| R_RDABZ | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-----|-----|------|----------|---------|----------------|----|----|----------------|----|----|----|
| Content | | | R_RD | R_Z_MODE | R_ABZ_E | R_ABZ_HYS[2:0] | | | R_ABZ_RES[3:0] | | | |

Register Function: This register is used for configuring "Rotation direction", "Z phase output form", "ABZ output enabling / disabling", "ABZ phase hysteresis" and "ABZ resolution". The register value is duplicated from corresponding memory after power on or, when the mode transferred to "Normal Mode" from "User Mode".

- a) **Rotation direction configuration:** The output direction can be set in if the angle data increases clockwise or clockwise (Refer to section 16). Relation between the rotation direction and RD is as following.

| Rotation Direction | R_RD | Default |
|--------------------|------|---------|
| CCW (+) | 0x0 | ● |
| CW (-) | 0x1 | |

- b) **Z phase output form configuration:** The Z phase can be set as either among two modes. One is a normal z phase output which carries out toggle at 0 degree position. The other is a switch output which keeps low state in more than 180 degree and high state in less than 180 degree. (Refer to section 14.3 ABZ output figure)

| Z phase output form | R_Z_MODE | Default |
|---------------------|----------|---------|
| Normal output | 0x0 | ● |
| Switch output | 0x1 | |

- c) **ABZ output enable configuration:** It is possible to disable the ABZ output as necessary. When the ABZ output is set to "inability (0x0)", the output becomes Hi-Z.

| ABZ Output State | R_ABZ_E | Default |
|---------------------------------------|---------|---------|
| ABZ Output Inability (Hi-Z output) | 0x0 | |
| ABZ Output | 0x1 | ● |

- d) **ABZ hysteresis configuration:** This configuration can be used to prevent unexpected ABZ pulses under noise influence. Relation between ABZ hysteresis and ABZ_HYS set value is as following.

| ABZ Hysteresis | R_ABZ_HYS[2:0] | Default |
|----------------|--------------------|---------|
| Invalid | 0x0 | |
| 0LSB | 0x1 | |
| 1LSB | 0x2, 0x5, 0x6, 0x7 | ● |
| 2LSB | 0x3 | |
| 3LSB | 0x4 | |

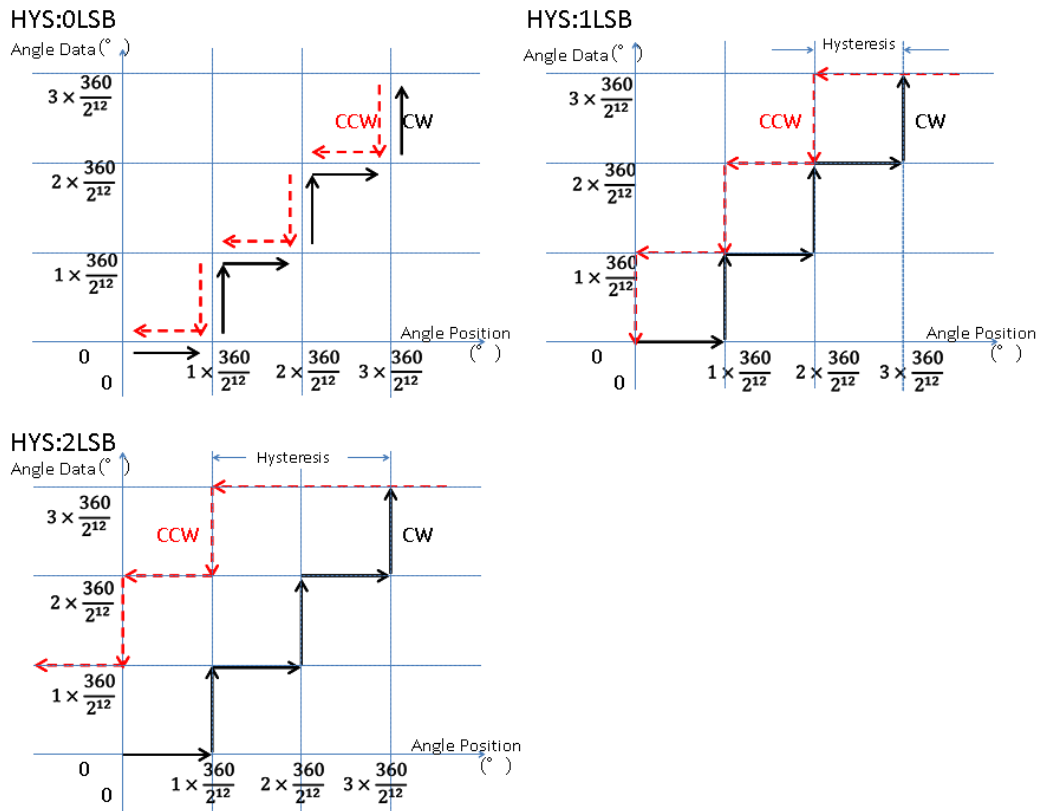


Figure 7. Operational Overview of Hysteresis Configuration

Note 13. As to the difference of ABZ hysteresis between “0LSB” and “Invalid”; Internal angle data always alternates between two adjacent angle data because of the tracking loop characteristics even if the environment is a static condition. In “Invalid” configuration, ABZ output is reflected by internal angle data directly. But in “0LSB” configuration, ABZ output is reflected by internal angle data when internal angle data change over two consecutive LSB in same rotation direction. Thus in this case, LSB bit alternation caused by noise is masked from ABZ output.

- e) **ABZ output resolution configuration:** Able to configure the ABZ resolution. Relation between ABZ resolution and set value is as following.

| ABZ phase resolution | R_ABZ_RES[D3:0] | Default |
|----------------------|-----------------|---------|
| 1024ppr | 0x0 | • |
| 512ppr | 0x1 | |
| 256ppr | 0x2 | |
| 128ppr | 0x3 | |
| 100ppr | 0x4 | |
| 900ppr | 0x5 | |
| 800ppr | 0x6 | |
| 700ppr | 0x7 | |
| 600ppr | 0x8 | |
| 500ppr | 0x9 | |
| 400ppr | 0xA | |
| 360ppr | 0xB | |
| 300ppr | 0xC | |
| 200ppr | 0xD | |
| 100ppr | 0xE | |
| 50ppr | 0xF | |

- R_MLK Register (Register Address : 0x08)

| R_MLK | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-----|-----|----|----|----|----|----|----|----|----|----|------------|
| Content | | | | | | | | | | | | R_MLK[1:0] |

Register Function: This register is to be duplicated from data at the memory lock configuration address on EEPROM. This address is read-only for confirming the memory lock state. Relation between the memory lock state and MLK register value is as following.

| Memory Lock State | R_MLK[1:0] | Default |
|-------------------|---------------|---------|
| Unlocked | 0x3 | • |
| Locked | 0x0, 0x1, 0x2 | |

- R_EBDIS Register (Register Address : 0x09)

| R_EBDIS | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-----|-----|----|----|----|----|----|----|----|----|----|--------------|
| Content | | | | | | | | | | | | R_EBDIS[1:0] |

Register Function: This register is used for disabling / enabling each abnormal diagnosis function as necessary. Relation between the diagnosis function and EBDIS is as following. Each bit have its function, and "1" means DISABLE. The register value is duplicated from corresponding memory after power on or, when the mode transferred to "Normal Mode" from "User Mode".

| Abnormal Diagnosis Parameter | Bit data | Default |
|------------------------------|------------|---------|
| Magnetic Flux Density | R_EBDIS[1] | 0 |
| Tracking Lost | R_EBDIS[0] | 0 |

- R_UVW Register (Register Address : 0x0A)

| R_UVW | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-----|-----|----|----|----|---------|----------------|----|----|----------------|----|----|
| Content | | | | | | R_UVW_E | R_UVW_HYS[2:0] | | | R_UVW_RES[2:0] | | |

Register Function: This register is used for configuring “UVW output enabling / disabling”, “UVW phase hysteresis”, “the number of UVW pulses per a rotation”.

The register value is duplicated from corresponding memory after power on or, when the mode transferred to "Normal Mode" from “User Mode”.

- a) **UVW output enable configuration:** It is possible to disable the UVW output as necessary. When the ABZ output is set to “inability (0x0)”, the output becomes Hi-Z.

| UVW Output State | R_UVW_E | Default |
|---------------------------------------|---------|---------|
| UVW output Inability (Hi-Z output) | 0x0 | |
| UVW output | 0x1 | • |

- b) **UVW hysteresis configuration:** This configuration can be used to prevent unexpected UVW pulses under noise influence. Relation between UVW hysteresis and UVW_HYS set value is as following.

| UVW Hysteresis | R_UVW_HYS[2:0] | Default |
|----------------|--------------------|---------|
| Invalid | 0x0 | |
| 0LSB | 0x1 | |
| 1LSB | 0x2, 0x5, 0x6, 0x7 | • |
| 2LSB | 0x3 | |
| 3LSB | 0x4 | |

- c) **The number of UVW pulses configuration:** It is possible to set the number of UVW pulses per a rotation by changing following bits according to the number of DCBL motor rotor’s magnetic poles.

| The number of UVW pulses | R_UVW_RES[2:0] | Default |
|--------------------------|----------------|---------|
| 1ppr | 0x0 | |
| 2ppr | 0x1 | |
| 3ppr | 0x2 | • |
| 4ppr | 0x3 | |
| 5ppr | 0x4 | |
| 6ppr | 0x5 | |
| 7ppr | 0x6 | |
| 8ppr | 0x7 | |

● EEPROM Address Map

Table 13. EEPROM Memory Address Map

| Addr.[HEX] | Memory symbol | R/W Permission | | Note |
|------------|---------------|----------------|-----------|---|
| | | Normal Mode | User Mode | |
| 0x00 | - | N.A. | N.A. | |
| 0x01 | - | N.A. | N.A. | |
| 0x02 | - | N.A. | N.A. | |
| 0x03 | - | N.A. | N.A. | |
| 0x04 | E_ID1 | N.A. | R/W | For ID data |
| 0x05 | E_ID2 | N.A. | R/W | For ID data |
| 0x06 | E_ZP | N.A. | R/W | For to set up angle zero point. |
| 0x07 | E_RDABZ | N.A. | R/W | For set up "Rotation direction", "Z phase output form", "ABZ output enable/disable", "ABZ Hysteresis" and "ABZ resolution". |
| 0x08 | E_MLK | N.A. | R/W | For memory lock |
| 0x09 | E_EBDIS | N.A. | R/W | For set up abnormal detection disable |
| 0x0A | E_UVW | N.A. | R/W | For set up "UVW output enable/disable", "UVW Hysteresis" and "UVW resolution". |

Note 14. Once set memory lock, this IC cannot be written to any memory.

Note 15. Each register value is duplicated from corresponding memory when the mode transferred to "Normal Mode" or re-power on. In order to reflect a setup data on an output, please return to a normal mode or re-power on.

● Each Memory Configurations

- E_ID1 Memory (Memory Address : 0x04)

| E_ID1 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-------------|-----|----|----|----|----|----|----|----|----|----|----|
| Content | E_ID1[11:0] | | | | | | | | | | | |

Memory Function: This memory can be written as identification information or the lot information by the IC user. Default value is 0x000.

- E_ID2 Memory (Memory Address : 0x05)

| E_ID2 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-------------|-----|----|----|----|----|----|----|----|----|----|----|
| Content | E_ID2[11:0] | | | | | | | | | | | |

Memory Function: This memory can be written as identification information or the lot information by the IC user. Default value is 0x000.

- E_ZP Memory (Memory Address : 0x06)

| E_ZP | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|------------|-----|----|----|----|----|----|----|----|----|----|----|
| Content | E_ZP[11:0] | | | | | | | | | | | |

Memory Function: This memory is available for setting arbitrarily angle position as zero position. Relation between the angle position and the ZP data is the following.

| Zero Point Angle Position [°] | E_ZP[11:0] | Default |
|-------------------------------|------------|---------|
| 0 | 0x000 | ● |
| (360÷4096) ×1 | 0x001 | |
| (360÷4096) ×2 | 0x002 | |
| (360÷4096) ×3 | 0x003 | |
| ⋮ | ⋮ | |
| (360÷4096) ×4095 | 0xFFFF | |

Note 16. A setup of this register and memory is reflected in ABZ and UVW output.

- E_RDABZ Memory (Memory Address : 0x07)

| E_RDABZ | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-----|-----|------|----------|---------|----------------|----|----|----------------|----|----|----|
| Content | | | E_RD | E_Z_MODE | E_ABZ_E | E_ABZ_HYS[2:0] | | | E_ABZ_RES[3:0] | | | |

Memory Function: This register is used for configuring “Rotation direction”, “Z phase output form”, “ABZ output enabling / disabling”, “ABZ phase hysteresis” and “ABZ resolution”.

Relation between each bit and setting value is as following.

- a) **Rotation direction configuration:** The output direction can be set in if the angle data increases clockwise or clockwise (Refer to section 16). Relation between the rotation direction and RD is as following.

| Rotation Direction | E_RD | Default |
|--------------------|------|---------|
| CCW (+) | 0x0 | ● |
| CW (-) | 0x1 | |

- b) **Z phase output form configuration:** The Z phase can be set as either among two modes One is a normal z phase output which carries out toggle at 0 degree position. The other is a switch output which keeps low state in more than 180 degree and high state in less than 180 degree. (Refer to section 14.3)

| Z phase output form | E_Z_MODE | Default |
|---------------------|----------|---------|
| Normal output | 0x0 | ● |
| Switch output | 0x1 | |

- c) **ABZ output enable configuration:** It is possible to disable the ABZ output as necessary. When the ABZ output is set to “inability (0x0)”, the output becomes Hi-Z.

| ABZ Output State | E_ABZ_E | Default |
|------------------------------------|---------|---------|
| ABZ Output Inability (Hi-Z output) | 0x0 | |
| ABZ Output | 0x1 | ● |

- d) **ABZ hysteresis configuration:** This configuration can be used to prevent unexpected ABZ pulses under noise influence. Relation between ABZ hysteresis and ABZ_HYS set value is as following.

| ABZ Hysteresis | E_ABZ_HYS[2:0] | Default |
|----------------|--------------------|---------|
| Invalid | 0x0 | |
| 0LSB | 0x1 | |
| 1LSB | 0x2, 0x5, 0x6, 0x7 | ● |
| 2LSB | 0x3 | |
| 3LSB | 0x4 | |

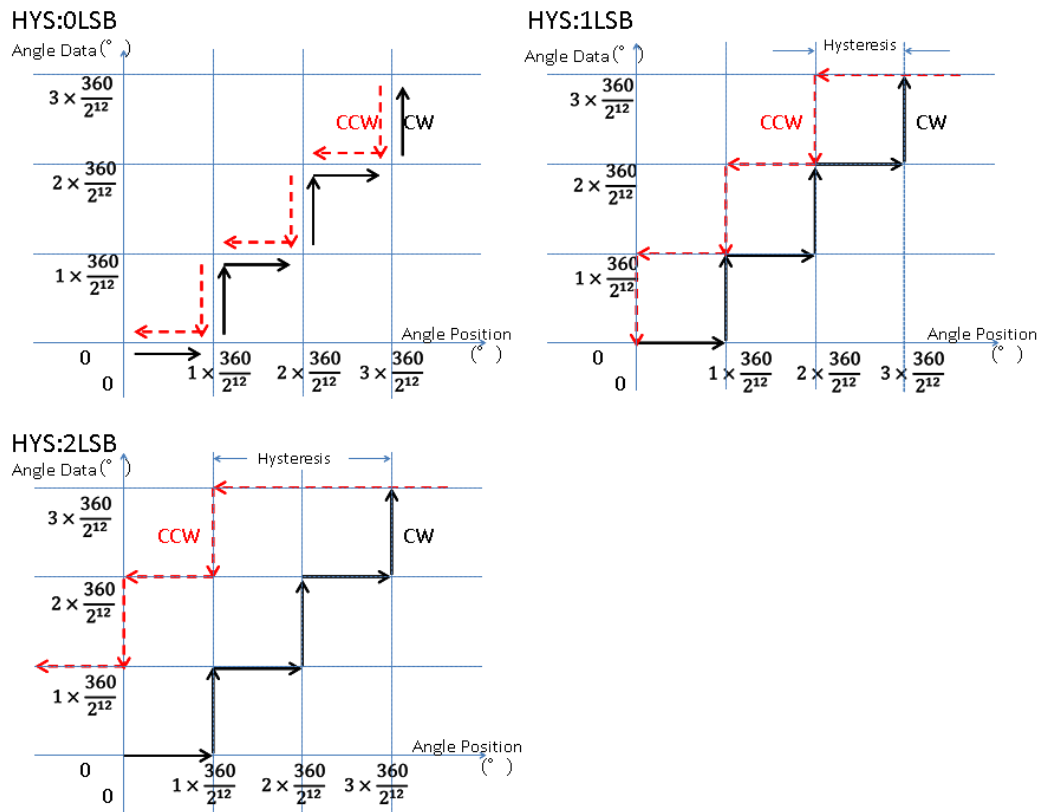


Figure 8. Operational Overview of Hysteresis Configuration

Note 17. As to the difference of ABZ hysteresis between “0LSB” and “Invalid”; Internal angle data always alternates between two adjacent angle data because of the tracking loop characteristics even if the environment is a static condition. In “Invalid” configuration, ABZ output is reflected by internal angle data directly. But in “0LSB” configuration, ABZ output is reflected by internal angle data when internal angle data change over two consecutive LSB in same rotation direction. Thus in this case, LSB bit alternation caused by noise is masked from ABZ output.

- e) **ABZ output resolution configuration:** Able to configure the ABZ resolution by using this configuration. Relation between ABZ resolution and set value is as following.

| ABZ phase resolution | ABZ_RES[3:0] | Default |
|----------------------|--------------|---------|
| 1024ppr | 0x0 | ● |
| 512ppr | 0x1 | |
| 256ppr | 0x2 | |
| 128ppr | 0x3 | |
| 1000ppr | 0x4 | |
| 900ppr | 0x5 | |
| 800ppr | 0x6 | |
| 700ppr | 0x7 | |
| 600ppr | 0x8 | |
| 500ppr | 0x9 | |
| 400ppr | 0xA | |
| 360ppr | 0xB | |
| 300ppr | 0xC | |
| 200ppr | 0xD | |
| 100ppr | 0xE | |
| 50ppr | 0xF | |

- E_MLK Memory (Memory Address : 0x08)

| E_MLK | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-----|-----|----|----|----|----|----|----|----|----|----|------------|
| Content | | | | | | | | | | | | E_MLK[1:0] |

Memory Function: This configuration is used for locking the memory.

By writing data [0x00] (except for 0x03) in address [0x08], the memory lock is executed. Once the memory is locked, all memory data cannot be changed, and also the memory lock function cannot be released.

| Memory Lock State | E_MLK[1:0] | Default |
|-------------------|---------------|---------|
| Unlocked | 0x3 | ● |
| Locked | 0x0, 0x1, 0x2 | |

- E_EBDIS Memory (Memory Address : 0x09)

| E_EBDIS | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-----|-----|----|----|----|----|----|----|----|----|----|--------------|
| Content | | | | | | | | | | | | E_EBDIS[1:0] |

Memory Function: This memory is used for disabling / enabling each abnormal diagnosis function as necessary. Relation between the diagnosis function and EBDIS is as following. By writing 1 in a corresponding bit, the abnormal diagnosis function is disabled.

| Abnormal Diagnosis Parameter | Bit data | Default |
|------------------------------|------------|---------|
| Magnetic Flux Density | E_EBDIS[1] | 0 |
| Tracking Lost | E_EBDIS[0] | 0 |

- E_UVW Memory (Memory Address : 0x0A)

| E_UVW | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|-----|-----|----|----|----|---------|----------------|----|----|----------------|----|----|
| Content | | | | | | E_UVW_E | E_UVW_HYS[2:0] | | | E_UVW_RES[2:0] | | |

Memory Function: This memory is used for configuring “UVW output enabling / disabling”, “UVW phase hysteresis”, “the number of UVW pulses per a rotation”. Relation between each bit and setting value is as following.

- a) **UVW output enable configuration:** It is possible to disable the UVW output as necessary. When the ABZ output is set to “inability (0x0)”, the output becomes Hi-Z.

| UVW Output State | E_UVW_E | Default |
|---------------------------------------|---------|---------|
| UVW output Inability (Hi-Z output) | 0x0 | |
| UVW output | 0x1 | ● |

- b) **UVW hysteresis configuration:** This configuration can be used to prevent unexpected UVW pulses under noise influence. Relation between UVW hysteresis and UVW_HYS set value is as following.

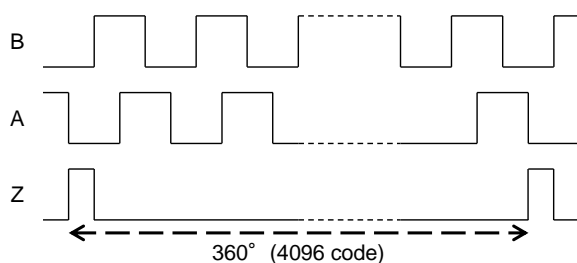
| UVW Hysteresis | E_UVW_HYS[2:0] | Default |
|----------------|--------------------|---------|
| Invalid | 0x0 | |
| 0LSB | 0x1 | |
| 1LSB | 0x2, 0x5, 0x6, 0x7 | ● |
| 2LSB | 0x3 | |
| 3LSB | 0x4 | |

- c) **The number of UVW pulses configuration:** It is possible to set the number of UVW pulses per a rotation by changing following bits according to the number of DCBL motor rotor’s magnetic poles.

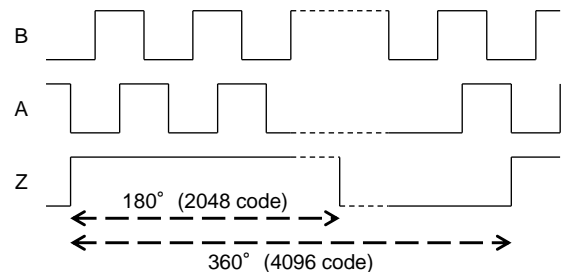
| The number of UVW pulses | E_UVW_RES[2:0] | Default |
|--------------------------|----------------|---------|
| 1ppr | 0x0 | |
| 2ppr | 0x1 | |
| 3ppr | 0x2 | ● |
| 4ppr | 0x3 | |
| 5ppr | 0x4 | |
| 6ppr | 0x5 | |
| 7ppr | 0x6 | |
| 8ppr | 0x7 | |

16. ABZ Output Figure

The ABZ output is following figure; The A and B are 1024pulses and Z pulse is outputted with one pulse during a rotation. (The number of A and B pulse is settable via SPI.). Moreover, the Z phase can be set to "Normal Output" which toggle at 0 degree position and "Switch Output" which keeps low state in more than 180 degree and high state in less than 180 degree.



Z phase normal output



Z phase switch output

Figure 9. ABZ Output figure

Note 28. Z-phase Output corresponds to the Zero point configuration which should be set by user.

The ABZ output is generated by the bit operation from 12 bit absolute angle data.

In order to generate the ABZ output, the angle data ANG[11:0] is once changed into ANG_ABZ[11:0] by the following operation.

$$\text{ANG_ABZ}[11:0] = \text{absolute angle data ANG}[11:0] \times (\text{ABZ resolution set value ABZ_RES[ppr]} \times 4) \div 4096$$

Then, From obtained ANG_ABZ[11:0], the A phase is generated by Bit1, and B phase is generated by Bit1 \oplus Bit0. Z phase is generated by NOR all 12bit data.

Note 19. When the ABZ output is except a exponentiation setup of 2, the angle linearity error deteriorates in range of -1 to 0 LSB(-0.088 to 0 degree.).

17. UVW Output Figure

This is a function which outputs the UVW signal which is needed for a DCBL motor drive. The UVW output can be set in the range of 1-8 pulses to one rotation. Moreover, U, V and W signal has 120 degree phase difference in an electric angle respectively. The zero point setup is reflected to start position of UVW.

Regarding the zero point setup, see the “ZP Register/Memory” setup in section 14.

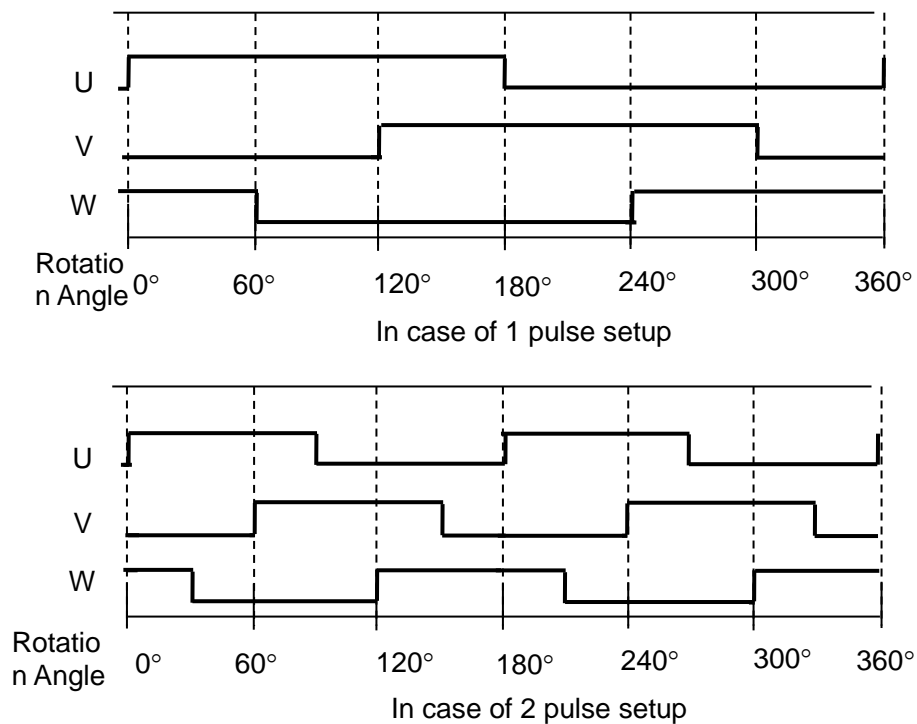


Figure 10. UVW Output figure

If there is difference between UVW and ABZ hysteresis, the start position of UVW phase shifts by the difference of UVW and ABZ hysteresis setup.

In order to generate the UVW output, the angle data ANG[11:0] is once changed into ANG_UVW[5:0] by the following operation.

$$\text{ANG_UVW}[5:0] = \text{absolute angle data ANG}[11:0] \times (\text{the number of UVW pulse set value UVW_RES[ppr]} \times 6) \div 4096$$

By using obtained ANG_UVW[5:0], each U, V and W phase signal is generated as following.

U : When ANG_UVW [5:0] value is from 6N to 6N+2, an output is high-level, and it is a low level when other.

V : When ANG_UVW [5:0] value is from 6N+2 to 6N+4, an output is high-level, and it is a low level when other.

W : When ANG_UVW [5:0] value is from 6N+1 to 6N+3, an output is low-level, and it is a High level when other.

Here, N means the order of output pulses. (from 0 to the number of pulses -1).

18. Abnormal Detection Functions

This IC detects an abnormal state and indicates an abnormal state via ERROR PIN and serial interface. Abnormal state is outputted at the angle output timing after 2.7ms(Typ) delay after detecting abnormal state.

1) Abnormal Detection Items

- Magnetic Flux Density Range Error
When IC is applied in less than 10mT(Typ), the abnormal state is detected.
- Tracking Lost
If the angle error in the tracking by the type 2 servo is greater than or equal to 2°, it will be tracking lost state (if the lock state is out due to type 2 servo). Because it is not overlooking the accurate absolute angle output in this state, it will be the anomaly detection state. Also monitoring of the abnormal state is every 2.56ms (Typ).

2) Output state in abnormal

The output is as following during abnormal state.

- ABZ and UVW Output
ABZ and UVW signal is outputted even if during abnormal state but the data may not be correct.
- SPI Output
The parity bits(P1 and P2 bit) and error bit is outputted as following.

| | P1 bit | P2 bit | E bit |
|----------------|-------------|-------------|-------|
| Normal State | ODD parity | ODD parity | 1 |
| Abnormal State | EVEN parity | EVEN parity | 0 |

- ERROR PIN Output
Output is low in abnormal state (high in normal state). The updating cycle of Error pin output is every 80μs(Typ.).

Note 20. When the abnormal state is released, IC returns to the normal output state automatically.

Note 21. In User mode, output on ERROR PIN is low state.

19. Angle Zero Position at Shipment, and Relation between Magnet Angle Position and Output

The relation between magnet angle position over the package and angle output data is as following in Configuration at shipment (Zero Point configuration: default).

The relation between the angle output of the following figure, a package, and a magnet position has a few degree error.

When the relation between an angle output and a magnet position correctly has to be decided, use a zero point setup.

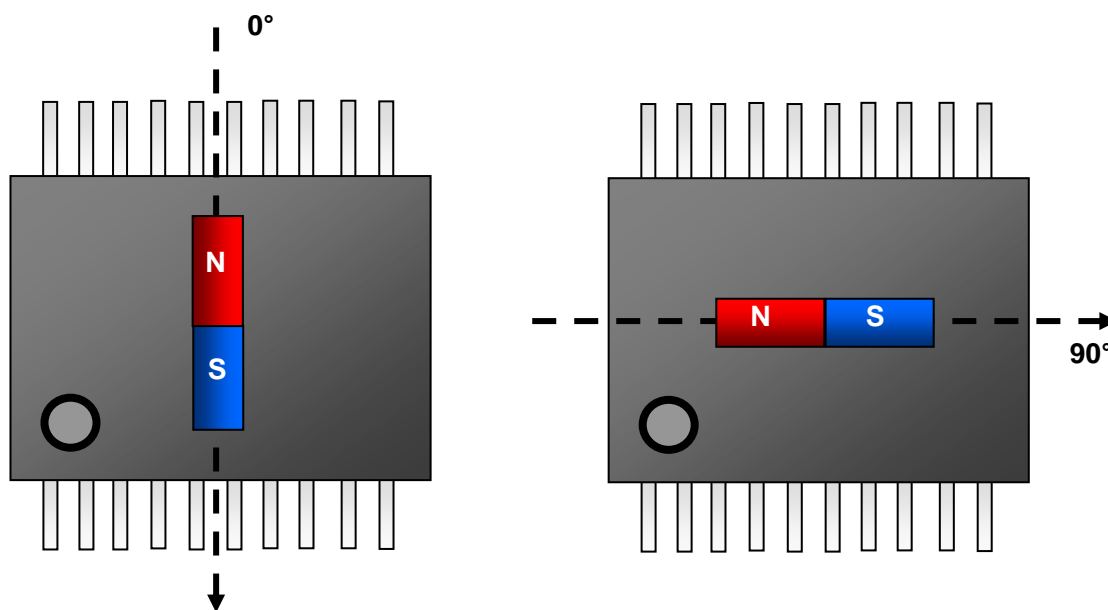


Figure 11. Relationship of Magnet position and the angle output at factory default setting

● Relation between Angle Position and Serial Angle Data

Relation between angle position and serial angle data is as following. When the zero point is configured, the zero point is the angle position 0° .

| Angle Position [$^\circ$] | Angle Data |
|-------------------------------|------------|
| 0 | 0x000 |
| $(360 \div 4096) \times 1$ | 0x001 |
| $(360 \div 4096) \times 2$ | 0x002 |
| $(360 \div 4096) \times 3$ | 0x003 |
| ⋮ | ⋮ |
| $(360 \div 4096) \times 4095$ | 0xFFF |

20. Package Information

20.1. Outline Dimensions

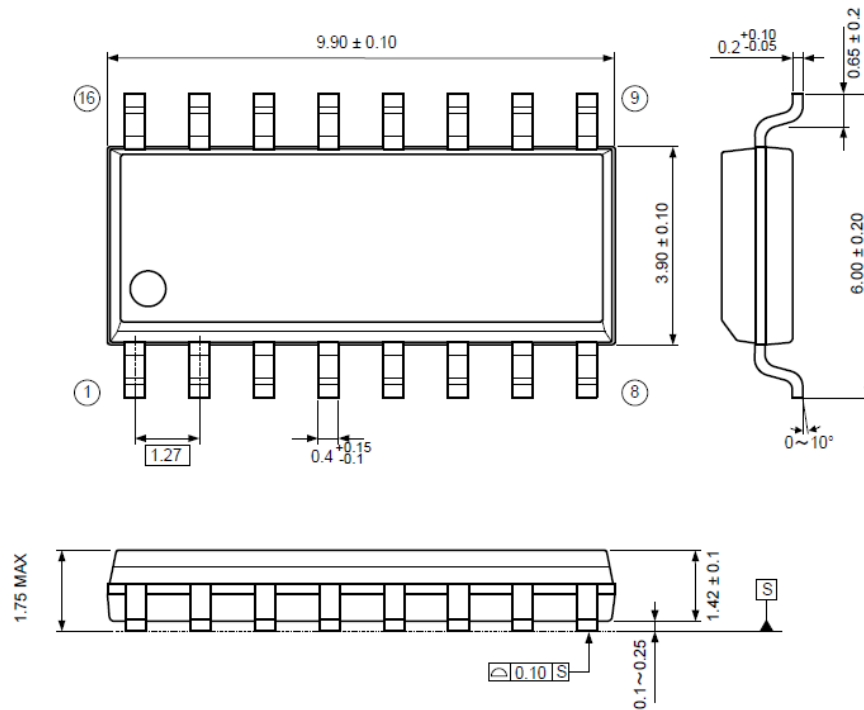
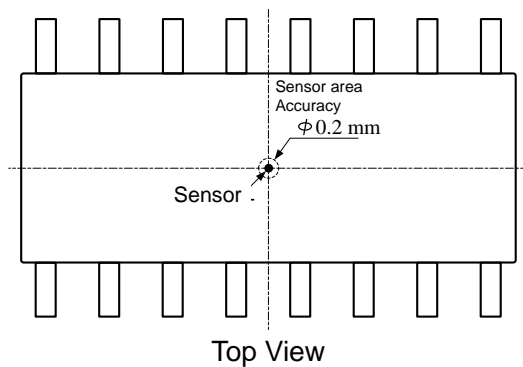
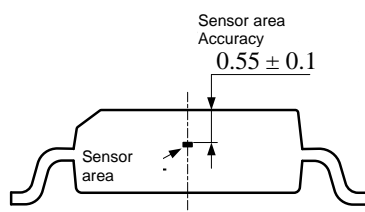


Figure 12. Package outline drawing

□ Sensor Position Information



Top View



Sectional View

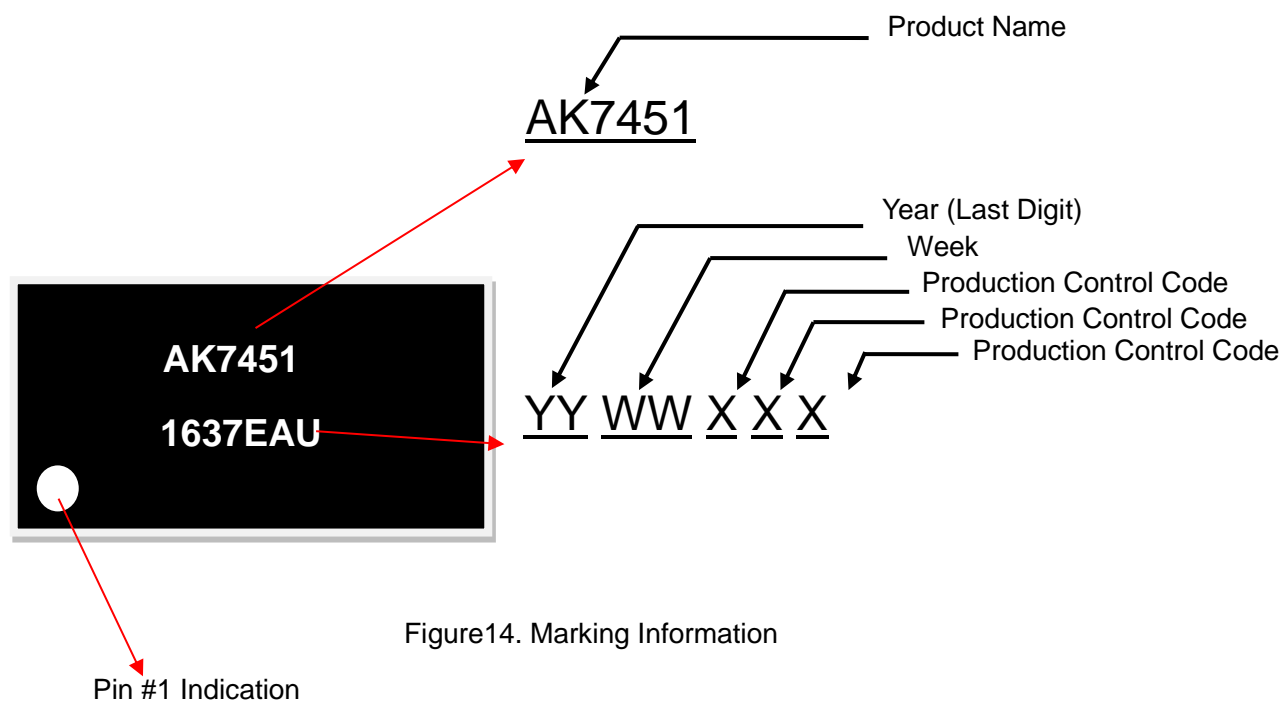
Figure 13. Sensor Position

- **Sensor Position Information**
The sensing area is embedded to the center of the PKG plane with 0.2mm allowance. And the depth is 0.55mm(typ.) from PKG surface.

The angle sensor needs to align the center of magnet and sensing area and rotation axis.

20.2. Marking

Production information is printed on the package surface by laser marking.



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